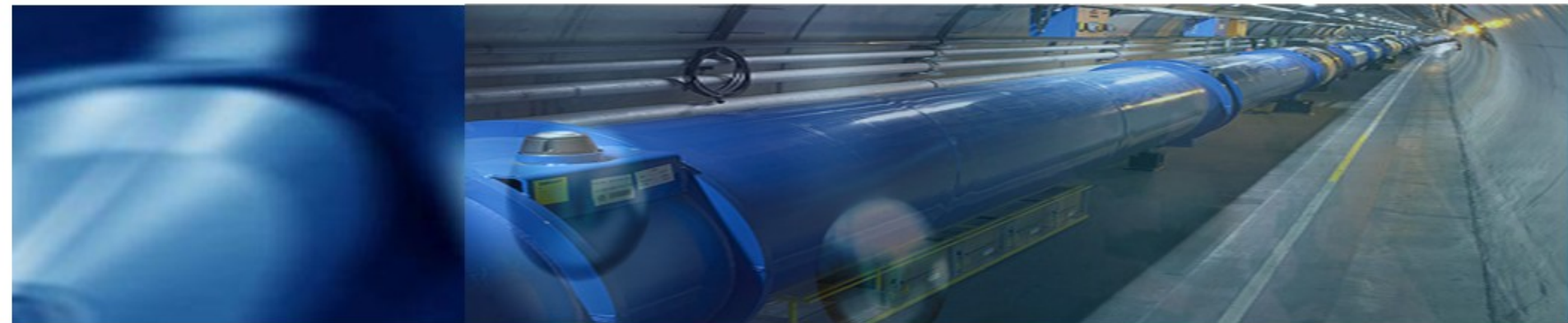


# Progress on FEV7/8 at SKKU



S.H. LEE, H.J. CHOI



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# Introduce

## CALICE Project

In particle physics, French scientists from Laboratoire de l'Accélérateur Linéaire (CNRS-IN2P3/Université Paris Sud) and Laboratoire Leprince-Ringuet (CNRS-IN2P3/Ecole Polytechnique) collaborate actively with Korean institutes to develop new detectors for the future **International Linear Collider** which is scheduled to start operation in 2020.



Omega

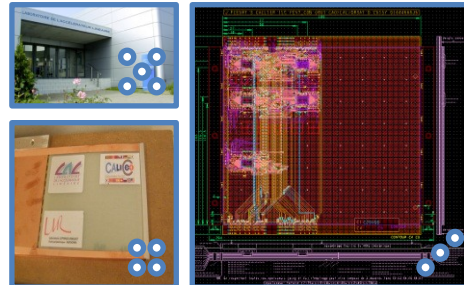
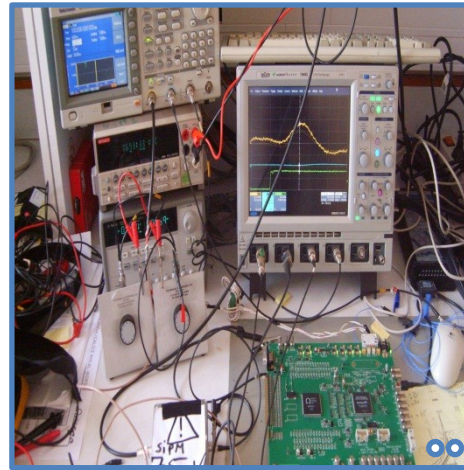
LMR



A & ME



# Research in the Omega



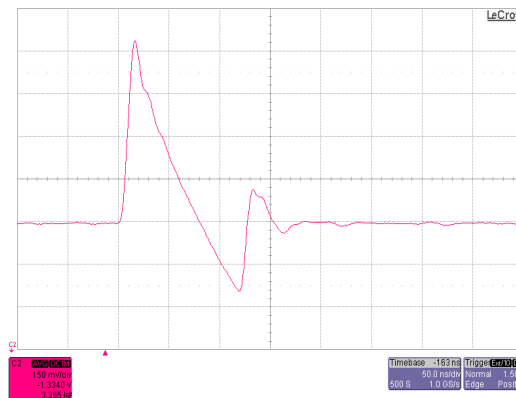
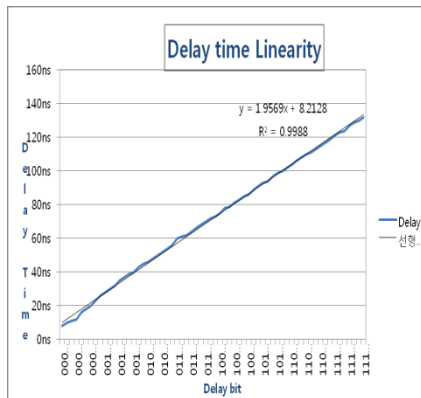
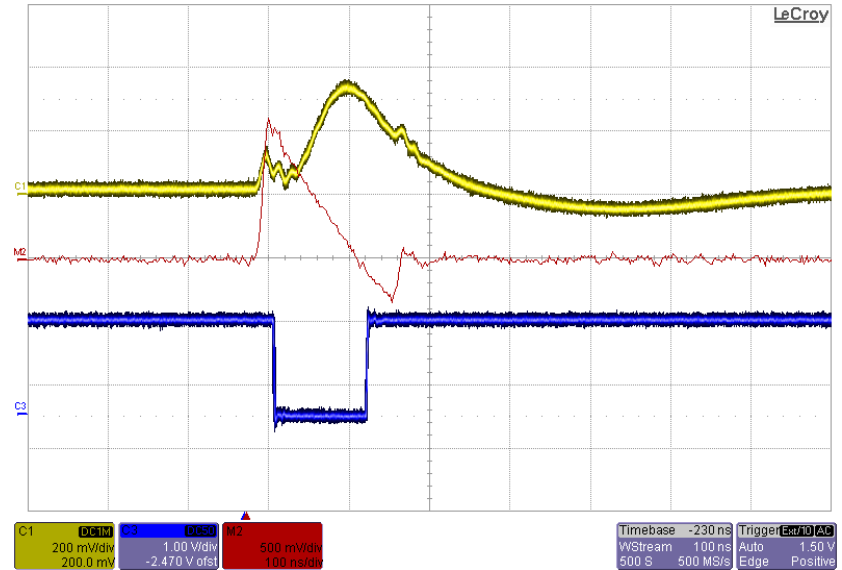
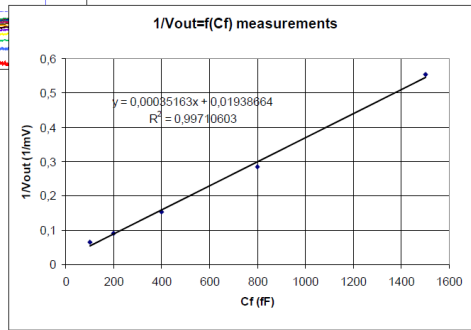
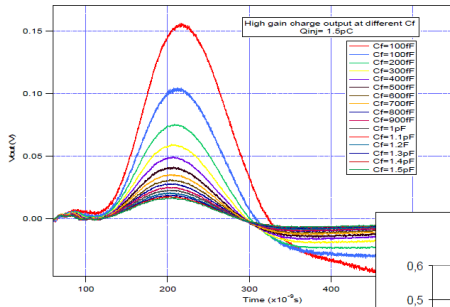
○ Research in Omega   ○○ Measurement   ○○○ FEV7   ○○○○ Mechanical   ○○○○○ LAL

During 5 months  
 in 2010,  
 I stayed in Omega  
 to research about  
 read-out chips and  
 FEV boards.

Ms. Choi stayed  
 during 2 months, also.

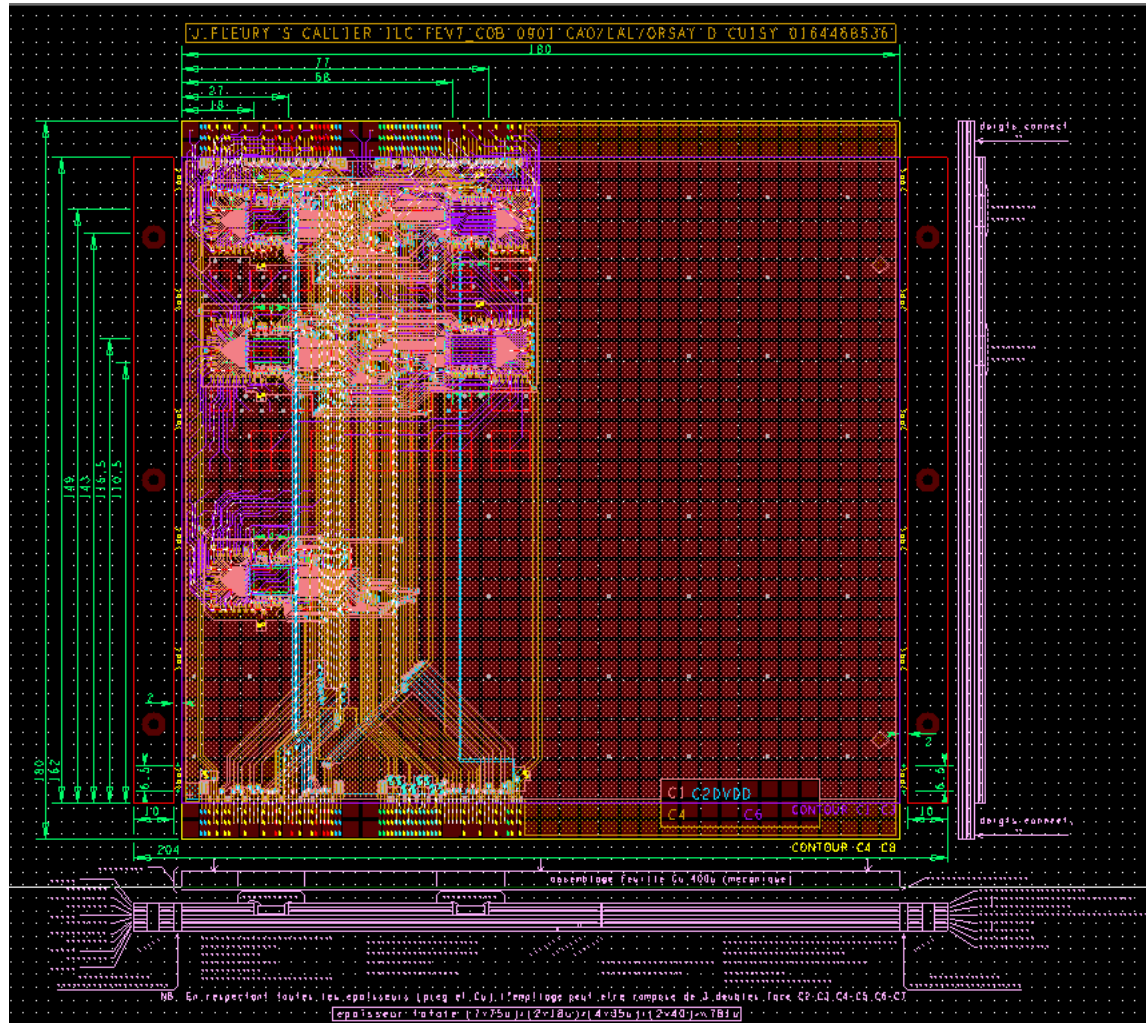
Co-work is really  
 helpful  
 both Korea and France  
 to go on the research  
 about CALICE project.

# Measurement of SPIROC 1 test board



Measurement of SPIROC 1 test board of analog signal.  
 Energy measurement  
 Time measurement  
 Trigger delay

# Design of FEV7 PCB



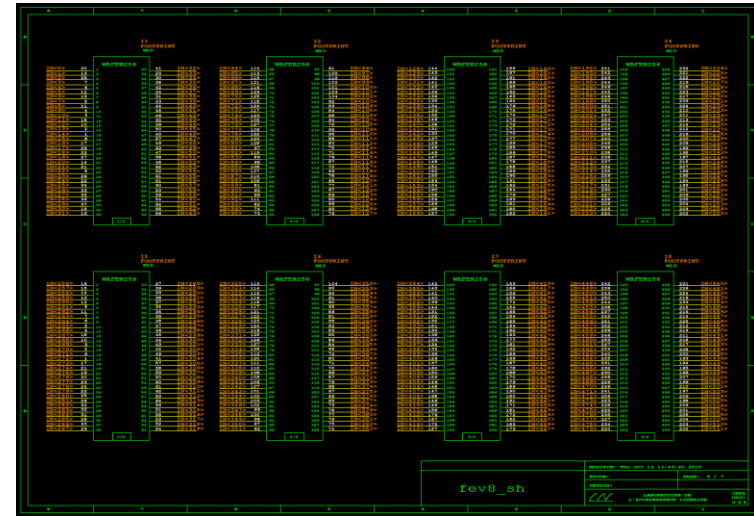
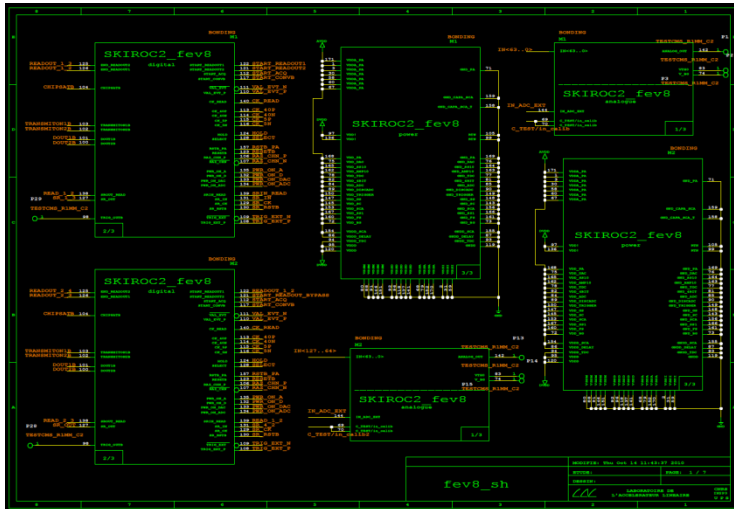
FEV7 CIP  
FEV7 COB1  
FEV7 COB2

**FEV7 COB1  
with 5chips**

## Purpose

1. Understand how to operate the board.
2. Become familiar with tools.
3. Design FEV7 boards.
4. Design new versions for manufacturing in Korea.

# Design of FEV8 Schematic



The next version of FEV board.

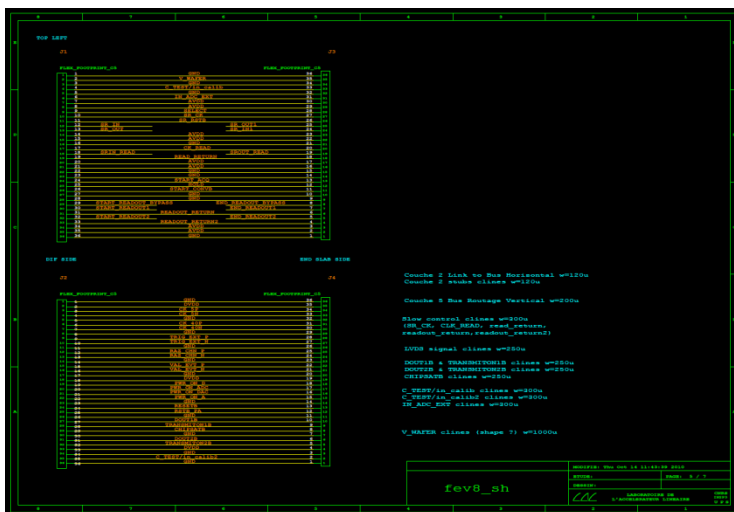
It will used for ECAL.

16 SKIROC2 chips

The final version of FEV board.

Laurens : 8 chips in only a left side.

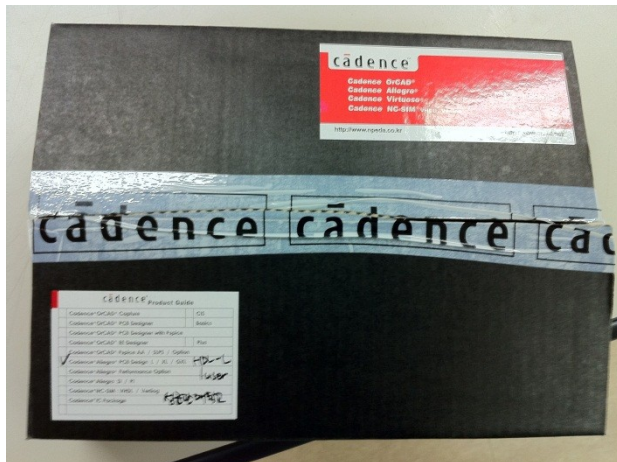
Ms. Choi : 16 chips in both sides.



# Progress at SKKU



1. Tools
  - Allegro Design Entry 16.3 HDL L
  - Allegro SI/PI
  - NI LabView 10.1
  - Tools for designing chips



2. Find some companies to make boards

*Unfortunately,  
Some problems have occurred!*





# Some Problems

## Technical problems

- very small diameter of vias and complicated structure to make
- digging some space to insert each chip(COB, COB2)

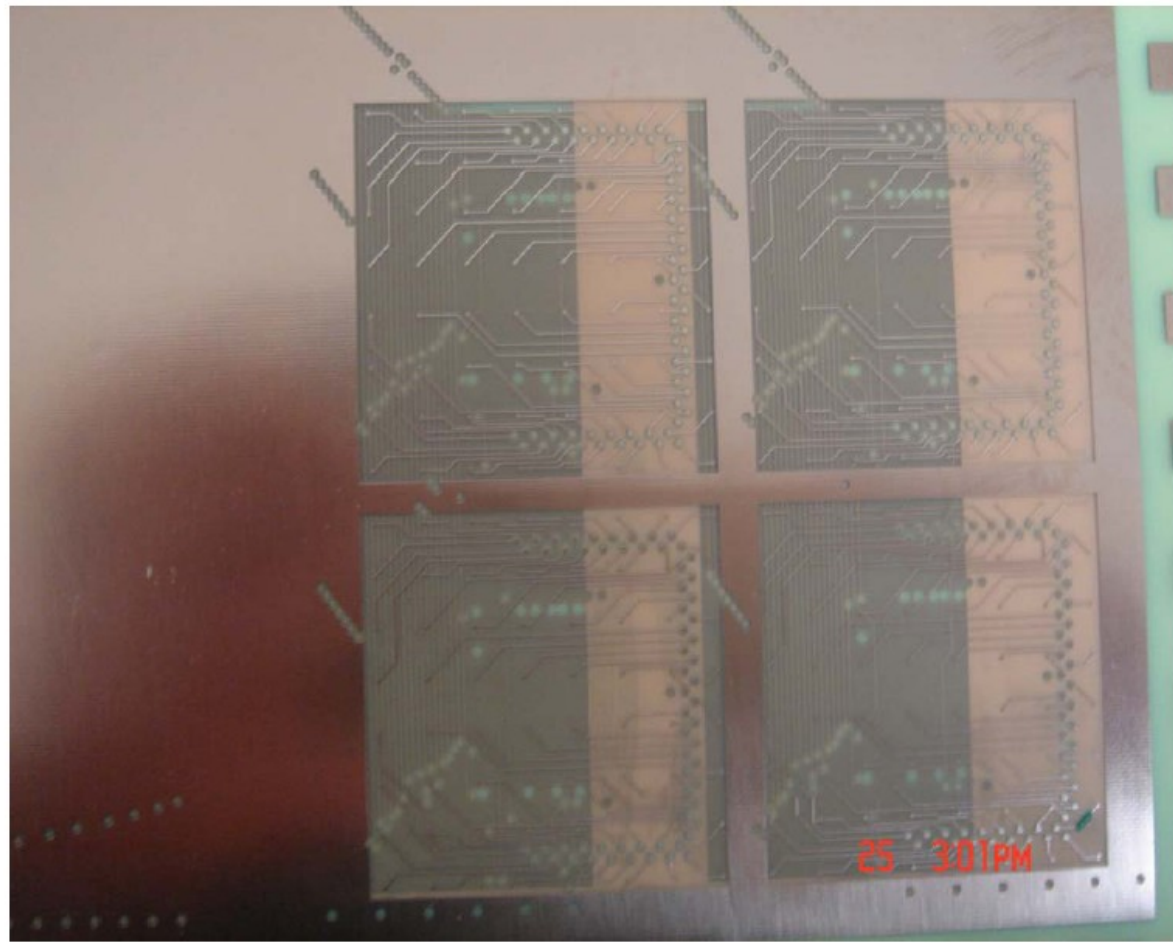
## Economical problems

- extremely difficult to success
- commercial production



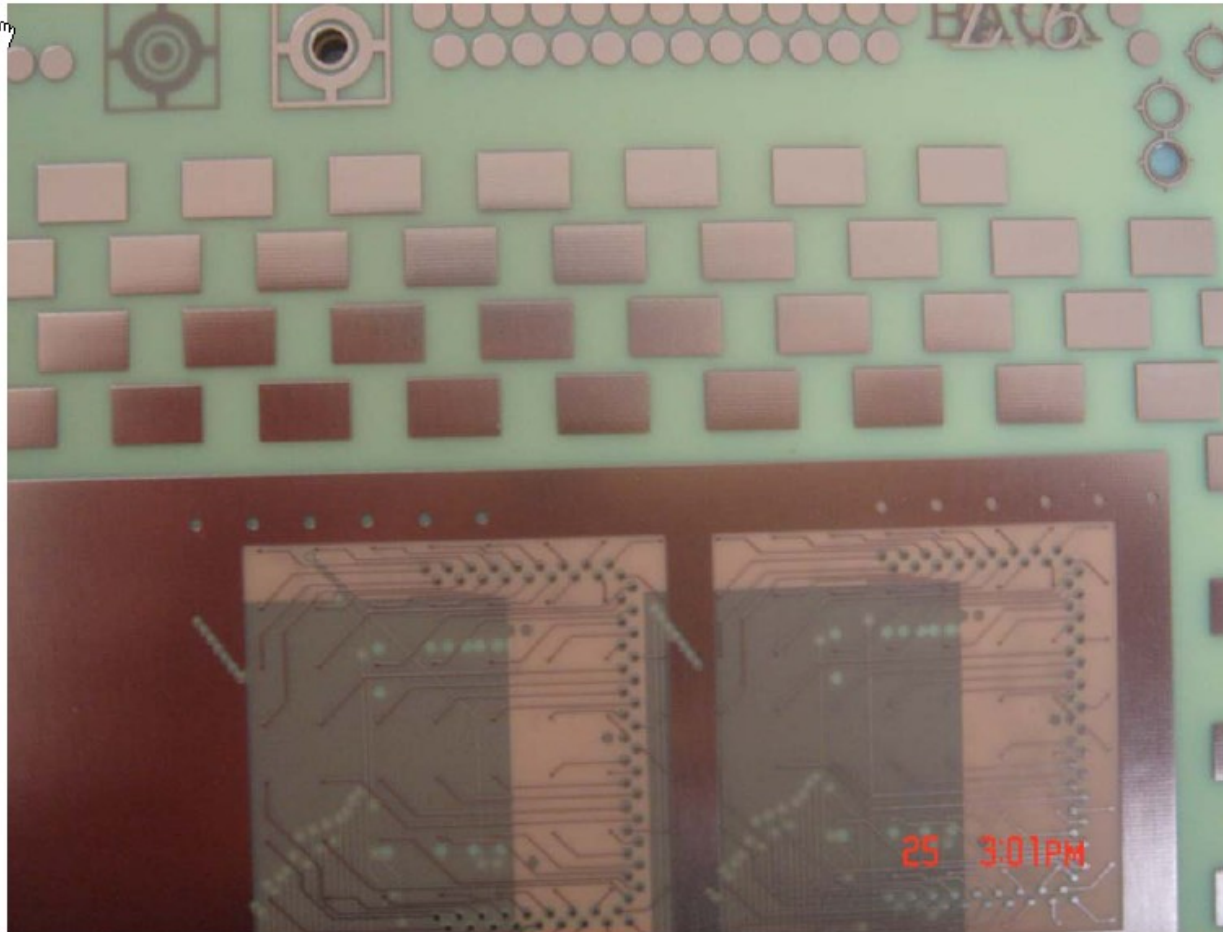
# Some Problems

Manufactured board in Korea



# Some Problems

Manufactured board in Korea





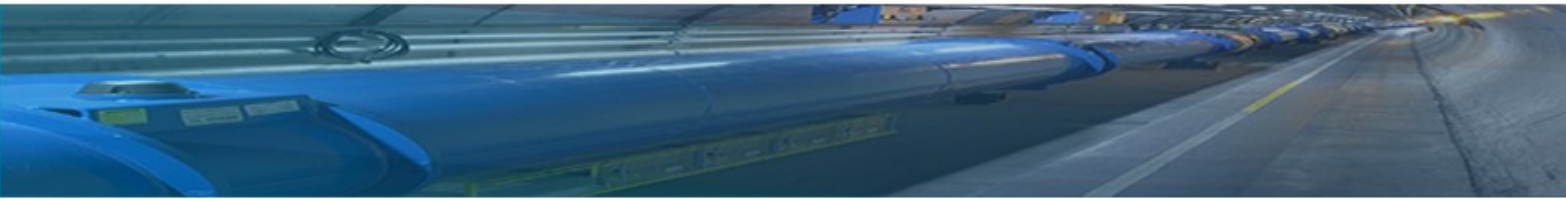
# Some Problems

## Problems

1. Spark at signal circuit
2. Leakage the current between conductors at the boards
3. Cut the circuit lines

## Improvement

1. Bilaminar PP
2. Adjustment of conductor thickness
3. Strengthen insulation



# Q & A



Thank You